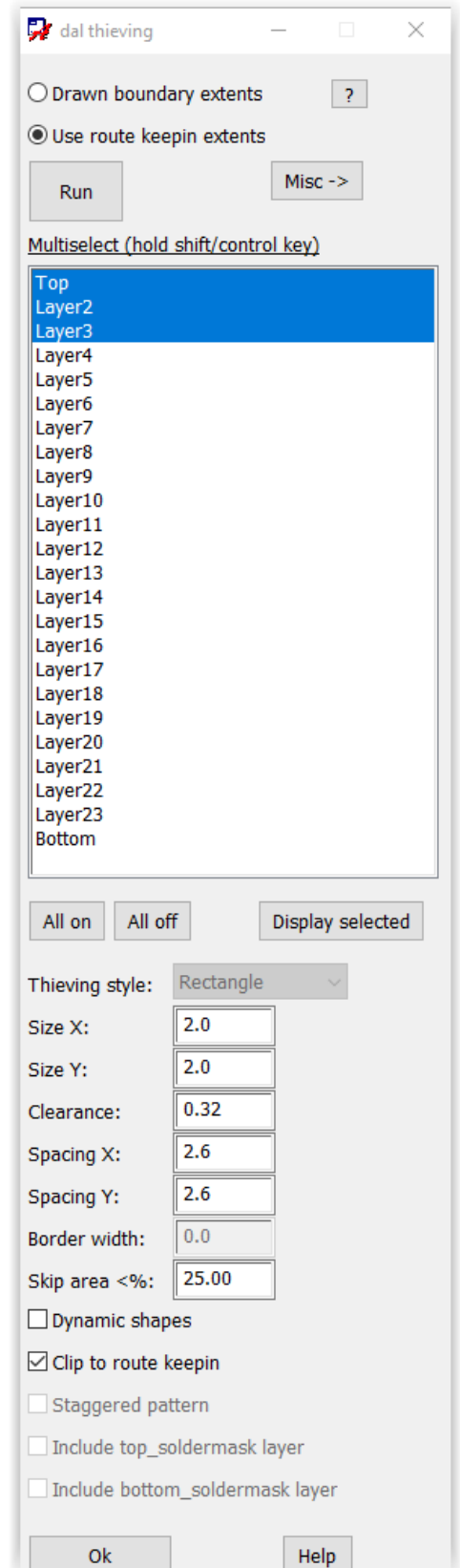
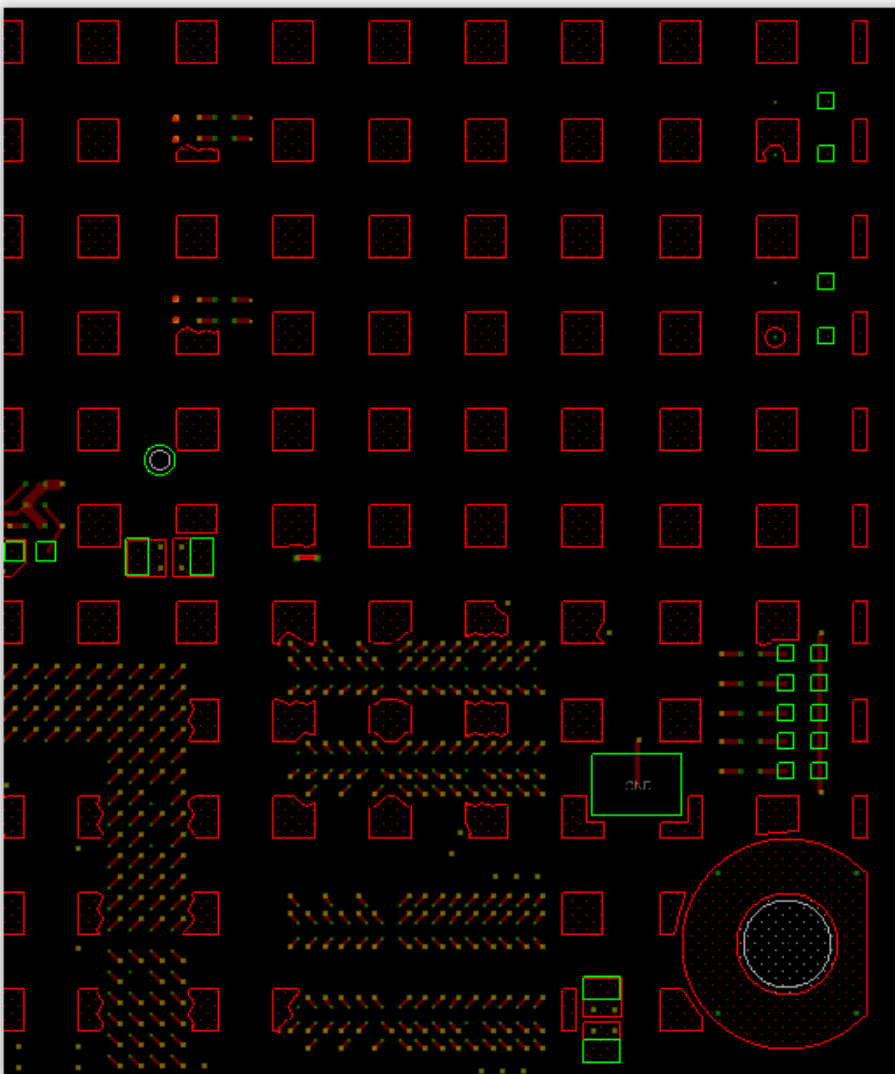


Thieving

Creates custom manufacturing etch “thieving” patterns on specified layers with enhanced parameters. Thieving copper is added to layers to create a uniform distribution of copper across the surface. This makes sure the copper plating and etch back is uniform.

Features:

- Provides better coverage with partial patterns when needed determined by DRC.
- Easy removal, highlighting and re-insertion by group.



Misc options

